



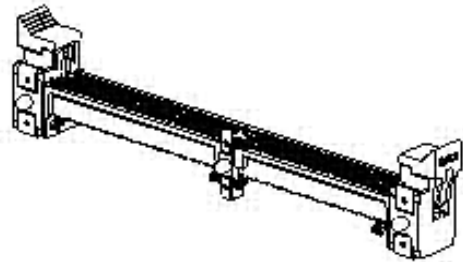
Part Number : [780011200](#)

Product Description : 0.60mm Pitch miniDIMM Socket, Surface Mount, Reverse Right-Angle, with Off-White Latches, 1.8V Voltage Key, 200 Circuits, Lead-Free

Series Number : 78001

Status : Obsolete

Product Category : Memory Module Connectors



Documents and Resources

Drawings

[780011200 sd.pdf](#)

[PK-78001-001-001.pdf](#)

[780011200 stp.zip](#)

[EE-78001-001-001.pdf](#)

[SP-78001-001-001.zip](#)

Specifications

[AS-87782-001-001.pdf](#)

[PS-78001-001-001.pdf](#)

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	 per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2023)3788-DC (14 Jun 2023)
EU RoHS	Compliant per EU 2015/863

[Compliance Statements](#)

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Obsolete
Category	Memory Module Connectors
Series	78001
Description	0.60mm Pitch miniDIMM Socket, Surface Mount, Reverse Right-Angle, with Off-White Latches, 1.8V Voltage Key, 200 Circuits, Lead-Free
Component Type	Socket
JEDEC Outline	MO-258
Product Name	MiniDIMM
UPC	822350071734

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	1.0A
Voltage Key	1.8V
Voltage - Maximum	30V

Physical

Circuits (Loaded)	200
Circuits (maximum)	200
Durability (mating cycles max)	25
Entry Angle	90° Angle (Side Entry)
Flammability	94V-0
Housing Color	Black
Keying to Mating Part	Yes
Latch Color	Natural (Off-White)
Material - Metal	Brass, Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	9.089/g
Packaging Type	Tray
PCB Locator	Yes
PCB Retention	Yes
Pitch - Mating Interface	0.60mm
Pitch - Termination Interface	0.60mm
Plating min - Mating	0.762µm
Plating min - Termination	3.810µm
Temperature Range - Operating	-55° to +85°C
Termination Interface Style	Surface Mount

Solder Process Data

Max-Duration	5
Lead-Free Process Capability	REFLOW
Max-Cycle	2
Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description	Part Number
Mates With	JEDEC MO-258 Modules

Obsolete